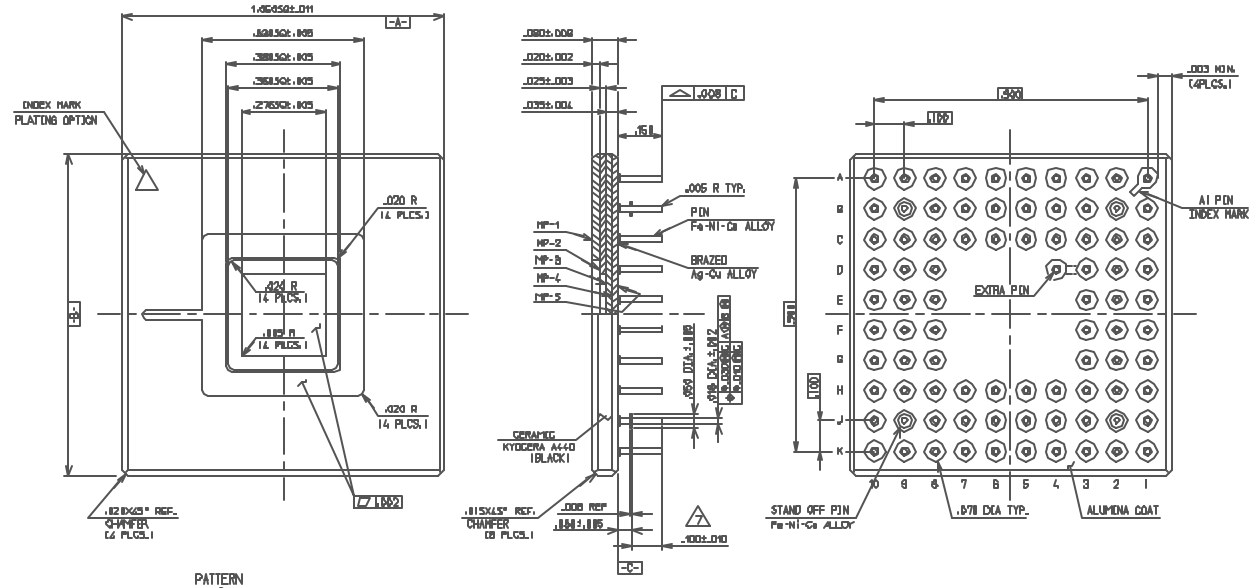
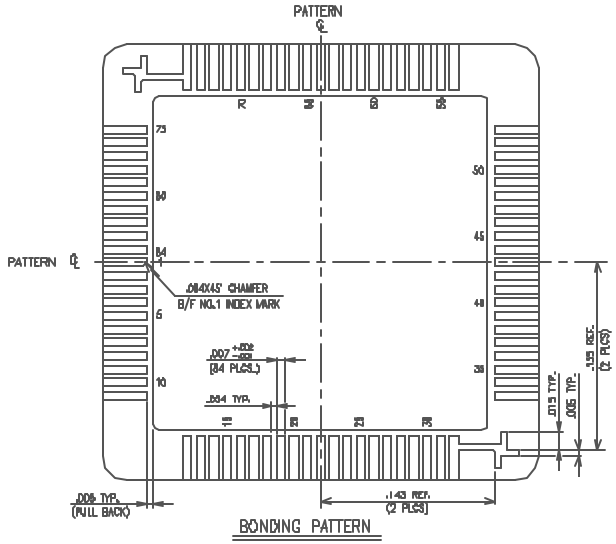
SSM P/N CPG08402

LTR	DESCRIPTION	DATE	APPROVAL
A	REVISED MIL-STD STYLE NUMBER	3-3-96	
B	PER KYOCERA KD-P9657B	6-26-96	





WIRE BOND PAD/CONNECTOR PIN INTERCONNECTION PLAN

W/B NO.	PIN NO.
1	F1
2	F2
3	F3
4	G1
5	H1
6	G2
7	J1
8	G3
9	K1
10	H2
11	J2
12	H3
13	J3
14	K2
15	K3
16	H4
17	J4
18	K4
19	J5
20	H5

W/B NO.	PIN NO.
21	K6
22	K5
23	J6
24	H6
25	K7
26	K8
27	J7
28	K9
29	H7
30	K10
31	J8
32	J9
33	H8
34	H9
35	J10
36	H10
37	G8
38	G9
39	G10
40	F9

W/B NO.	PIN NO.
41	F8
42	F10
43	E10
44	E9
45	E8
46	D10
47	C10
48	D9
49	B10
50	D8
51	A10
52	C9
53	B9
54	C8
55	B8
56	A9
57	A8
58	C7
59	B7
60	A7

W/B NO.	PIN NO.
61	B6
62	C6
63	A6
64	A5
65	B5
66	C5
67	A4
68	A3
69	B4
70	A2
71	C4
72	A1
73	B3
74	B2
75	C3
76	C2
77	B1
78	C1
79	D3
80	D2

W/B NO.	PIN NO.
81	D1
82	E2
83	E3
84	E1

EXTRA PIN D4	D3
S/R	NC

NOTES:

1. PLATING THICKNESS TO BE 60 MICRO INCHES MINIMUM GOLD OVER 50 – 350 MICRO INCHES NICKEL.
2. SEAL AREA TO BE METALLIZED.
3. DIE ATTACH AREA NOT TO BE METALLIZED.
4. SEAL RING TO BE FLOATING FROM ANY PINS.
5. LEAD RESISTANCE: 850 mΩ MAX.
6. EQUIVALENT TO KYOCERA DWG KD-P9657B.
7. MEETS OR EXCEEDS MIL-STD-1835A STYLE CMGA2-P85, EXCEPT PIN PROTRUSION.

REVIEW CLASS 3

Next Assy	Qty	DWN Drawn	12-18-94 Date
Check	Date		
Approved	Date		
Approved	Date		
Approved	Date		
Approved	Date		

Dimensions in Inches [ ] Millimeters

88 CPGA
.276" SQ. CAVITY

CAGE CODE	SIZE	DRAWING NO.	REV
LR	D	6300557	B

Scale 5:1 | CAD File No. D9657PKG | Sheet 1 of 1

SPECTRUM SEMICONDUCTOR MATERIALS, INC.
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